



#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

### **Product Summary**

| Device | V <sub>(BR)DSS</sub> | R <sub>DS(ON)</sub> max        | $I_D$ max<br>$T_A = +25$ °C |
|--------|----------------------|--------------------------------|-----------------------------|
| 01     | 20                   | 0.4Ω @ V <sub>GS</sub> = 10V   | 0.65A                       |
| Q1     | 30                   | $0.7\Omega$ @ $V_{GS} = 4.5V$  | 0.52A                       |
| 00     | -30                  | 0.9Ω @ V <sub>GS</sub> = -10V  | -0.45A                      |
| Q2     |                      | 1.7Ω @ V <sub>GS</sub> = -4.5V | -0.33A                      |

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor Control
- **Power Management Functions**
- **DC-DC Converters**

### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

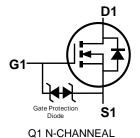
- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.027 grams (Approximate)

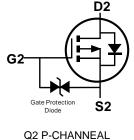


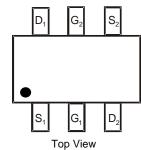




Top View







Pin out

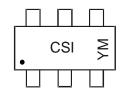
Ordering Information (Note 4)

| Part Number   | Case   | Packaging         |
|---------------|--------|-------------------|
| DMC3400SDW-7  | SOT363 | 3000/Tape & Reel  |
| DMC3400SDW-13 | SOT363 | 10000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**



CSI = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$ = Year (ex: B = 2014) M = Month (ex: 9 = September)

Date Code Key

| Year  | 201 | 4   | 2015 |     | 2016 | 20  | 17  | 2018 |     | 2019 | 2   | 2020 |
|-------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Code  | В   |     | С    |     | D    |     | E   | F    |     | G    |     | Н    |
| Month | Jan | Feb | Mar  | Apr | May  | Jun | Jul | Aug  | Sep | Oct  | Nov | Dec  |
| Code  | 1   | 2   | 3    | 4   | 5    | 6   | 7   | 8    | 9   | 0    | N   | D    |



### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic   | Symbol    | Value_Q1 | Value_Q2        | Units          |     |   |
|--|-----------|----------|-----------------|----------------|-----|---|
| Drain-Source Voltage   |           |          |                 | 30             | -30 | V |
| Gate-Source Voltage  | $V_{GSS}$ | ±20      | ±20             | V              |     |   |
| Continuous Drain Current (Note 6) $V_{GS} = 10V$ Steady $T_A = +25^{\circ}C$<br>State $T_A = +70^{\circ}C$ |           | In       | 0.65<br>0.50    | -0.45<br>-0.36 | Α   |   |
| Maximum Continuous Body Diode Forward Currer   | Is        | 0.4      | -0.35           | Α              |     |   |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1   | %)        |          | I <sub>DM</sub> | 4              | -3  | Α |

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                   |              | Symbol            | Value       | Units |
|--|--------------|-------------------|-------------|-------|
| Total Power Dissipation (Note 5)                 |              | $P_{D}$           | 0.31        | W     |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | $R_{\theta JA}$   | 406         | °C/W  |
| Total Power Dissipation (Note 6)                 |              | $P_{D}$           | 0.39        | W     |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | $R_{\theta JA}$   | 319         | °C/W  |
| Thermal Resistance, Junction to Case             |              | R <sub>0</sub> JC | 126         | °C/W  |
| Operating and Storage Temperature Range          |              | $T_{J,}T_{STG}$   | -55 to +150 | °C    |

## Electrical Characteristics – N Channel – Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

|  | 0                   | N#: | T    |     | 11!4 | T1 0  |  |
|--|---------------------|-----|------|-----|------|---|--|
| Characteristic (Characteristic (Characteristi (Characteristi (Characteristic (Characteristic (Characteristic ( | Symbol              | Min | Тур  | Max | Unit | Test Condition                              |  |
| OFF CHARACTERISTICS (Note 7)   |                     | 1   |      |     |      |   |  |
| Drain-Source Breakdown Voltage   | BV <sub>DSS</sub>   | 30  | -    | -   | V    | $V_{GS} = 0V, I_D = 250\mu A$               |  |
| Zero Gate Voltage Drain Current  | I <sub>DSS</sub>    | -   | -    | 1   | μΑ   | $V_{DS} = 24V, V_{GS} = 0V$                 |  |
| Gate-Source Leakage  | I <sub>GSS</sub>    | -   | -    | ±10 | μΑ   | $V_{GS} = \pm 16V, V_{DS} = 0V$             |  |
| ON CHARACTERISTICS (Note 7)  |                     |     |      |     |      |   |  |
| Gate Threshold Voltage   | V <sub>GS(TH)</sub> | 0.8 | -    | 1.6 | V    | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$        |  |
| Static Drain-Source On-Resistance  |                     | -   | 0.2  | 0.4 | Ω    | $V_{GS} = 10V, I_D = 0.59A$                 |  |
| Static Diani-Source Off-Resistance   | R <sub>DS(ON)</sub> | =   | 0.3  | 0.7 | 12   | $V_{GS} = 4.5V, I_D = 0.2A$                 |  |
| Diode Forward Voltage  | V <sub>SD</sub>     | -   | 0.8  | 1.2 | V    | $V_{GS} = 0V, I_S = 0.23A$                  |  |
| DYNAMIC CHARACTERISTICS (Note 8)   |                     |     |      |     |      |   |  |
| Input Capacitance  | C <sub>iss</sub>    | -   | 55   | -   | pF   |   |  |
| Output Capacitance   | Coss                | -   | 8.5  | -   | pF   | $V_{DS} = 15V, V_{GS} = 0V,$<br>-f = 1.0MHz |  |
| Reverse Transfer Capacitance   | C <sub>rss</sub>    | -   | 6.5  | -   | pF   | 1 = 1.0WH12                                 |  |
| Gate Resistance  | Rg                  | -   | 92   | -   | Ω    | $V_{DS} = V_{GS} = 0V$ , $f = 1.0MHz$       |  |
| Total Gate Charge (V <sub>GS</sub> = 4.5V)   | Qg                  | -   | 0.6  | -   | nC   |   |  |
| Total Gate Charge (V <sub>GS</sub> = 10V)  | Qg                  | -   | 1.4  | -   | nC   | $V_{DS} = 10V,$                             |  |
| Gate-Source Charge   | Q <sub>gs</sub>     | -   | 0.2  | -   | nC   | I <sub>D</sub> = 250mA                      |  |
| Gate-Drain Charge  | Q <sub>gd</sub>     | -   | 0.1  | -   | nC   |   |  |
| Turn-On Delay Time   | t <sub>D(ON)</sub>  | -   | 3.8  | -   | ns   |   |  |
| Turn-On Rise Time  | t <sub>R</sub>      | -   | 3.5  | -   | ns   | $V_{GS} = 10V, V_{DS} = 30V,$               |  |
| Turn-Off Delay Time  | t <sub>D(OFF)</sub> | -   | 25.2 | -   | ns   | $I_D = 100$ mA, $R_G = 1\Omega$             |  |
| Turn-Off Fall Time   | t <sub>F</sub>      | -   | 18.8 | -   | ns   |   |  |



## Electrical Characteristics – P Channel – Q2 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                              | Symbol              | Min | Тур  | Max  | Unit | Test Condition                                  |  |
|---|---------------------|-----|------|------|------|---|--|
| OFF CHARACTERISTICS (Note 7)                |                     |     |      |      |      |   |  |
| Drain-Source Breakdown Voltage              | BV <sub>DSS</sub>   | -30 | -    | -    | ٧    | $V_{GS} = 0V, I_D = -250\mu A$                  |  |
| Zero Gate Voltage Drain Current             | I <sub>DSS</sub>    | -   | -    | -1   | μΑ   | $V_{DS} = -24V, V_{GS} = 0V$                    |  |
| Gate-Source Leakage                         | I <sub>GSS</sub>    | -   | -    | ±10  | μΑ   | $V_{GS} = \pm 16V, V_{DS} = 0V$                 |  |
| ON CHARACTERISTICS (Note 7)                 |                     |     |      |      |      |   |  |
| Gate Threshold Voltage                      | V <sub>GS(TH)</sub> | -1  | -    | -2.6 | V    | $V_{DS} = V_{GS}$ , $I_D = -250\mu A$           |  |
| Static Drain-Source On-Resistance           |                     | -   | 0.36 | 0.9  | Ω    | $V_{GS} = -10V, I_D = -0.42A$                   |  |
| Static Drain-Source On-Resistance           | R <sub>DS(ON)</sub> | -   | 0.57 | 1.7  | Ω    | $V_{GS} = -4.5V$ , $I_{D} = -0.2A$              |  |
| Diode Forward Voltage                       | V <sub>SD</sub>     | -   | -0.8 | -1.2 | V    | $V_{GS} = 0V, I_{S} = -0.23A$                   |  |
| DYNAMIC CHARACTERISTICS (Note 8)            |                     |     |      |      |      |   |  |
| Input Capacitance                           | C <sub>iss</sub>    | -   | 54   | -    | pF   | 151/11/   |  |
| Output Capacitance                          | Coss                | -   | 10   | -    | рF   | $V_{DS} = -15V, V_{GS} = 0V,$<br>- f = 1.0MHz   |  |
| Reverse Transfer Capacitance                | Crss                | -   | 8.3  | -    | pF   | 1 – 1.01/11/12                                  |  |
| Gate Resistance                             | Rg                  | -   | 240  | -    | Ω    | $V_{DS} = V_{GS} = 0V$ , $f = 1.0MHz$           |  |
| Total Gate Charge (V <sub>GS</sub> = -4.5V) | Qg                  | -   | 0.6  | -    | nC   |   |  |
| Total Gate Charge (V <sub>GS</sub> = -10V)  | Qg                  | -   | 1.3  | -    | nC   | V <sub>DS</sub> = -10V. I <sub>D</sub> = -0.24A |  |
| Gate-Source Charge                          | Q <sub>gs</sub>     | -   | 0.2  | -    | nC   | $V_{DS} = -10V, I_{D} = -0.24A$                 |  |
| Gate-Drain Charge                           | Q <sub>gd</sub>     | -   | 0.2  | -    | nC   |   |  |
| Turn-On Delay Time                          | t <sub>D(ON)</sub>  | -   | 5.7  | -    | ns   |   |  |
| Turn-On Rise Time                           | t <sub>R</sub>      | -   | 8.8  | -    | ns   | $V_{GS} = -10V, V_{DD} = -15V,$                 |  |
| Turn-Off Delay Time                         | t <sub>D(OFF)</sub> | -   | 35   | -    | ns   | $I_D = -0.5A, R_G = 1\Omega$                    |  |
| Turn-Off Fall Time                          | t <sub>F</sub>      | -   | 19   | -    | ns   |   |  |

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
  Short duration pulse test used to minimize self-heating effect.
  Guaranteed by design. Not subject to product testing.

T<sub>A</sub>=25℃

T<sub>A</sub>=-55°C

I<sub>D</sub>=200mA

 $V_{GS}$ =4.5V,  $I_D$ =200mA

100

125

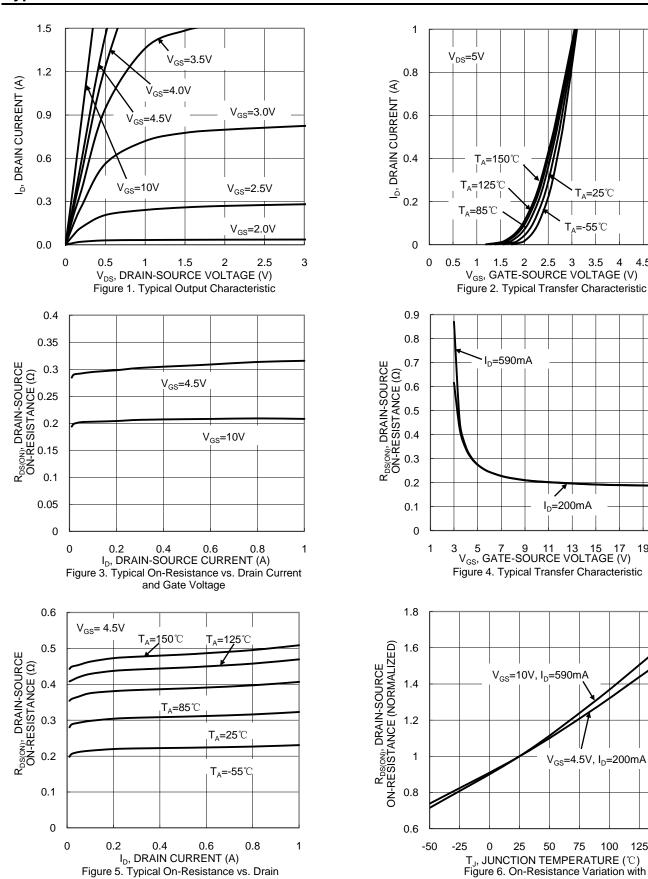
50

Temperature

75

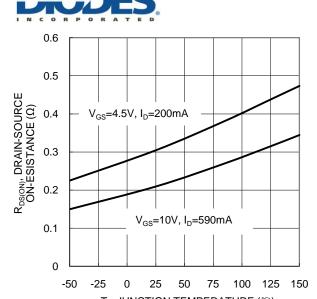


### **Typical Characteristics - N-CHANNEL**

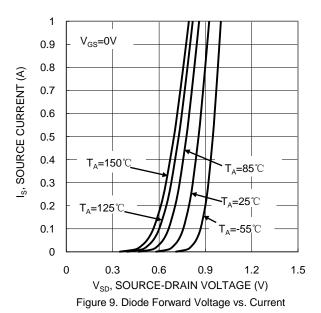


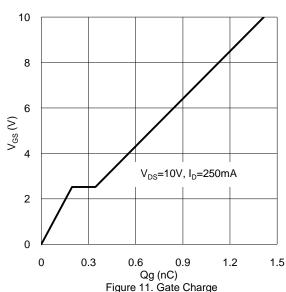
**Current and Temperature** 

150



 $T_J$ , JUNCTION TEMPERATURE ( $^{\circ}$ C) Figure 7. On-Resistance Variation with Temperature





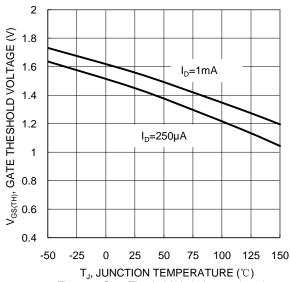
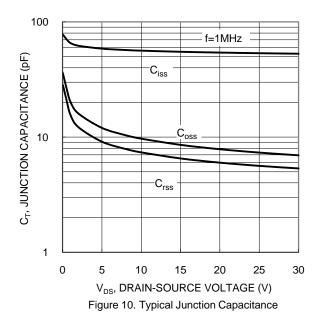


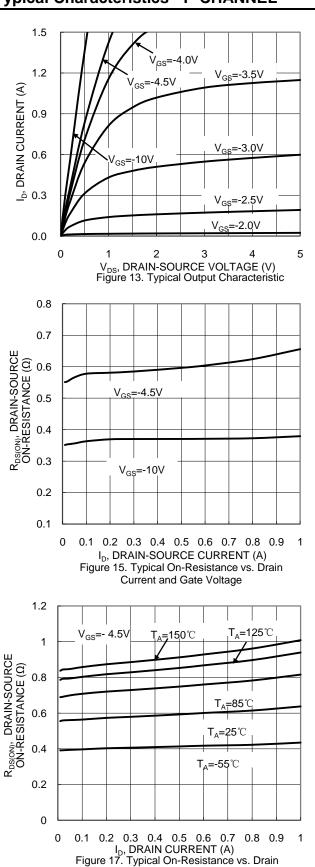
Figure 8. Gate Theshold Variation vs. Junction Temperature

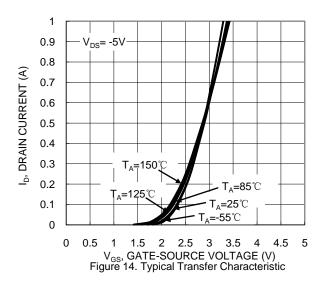


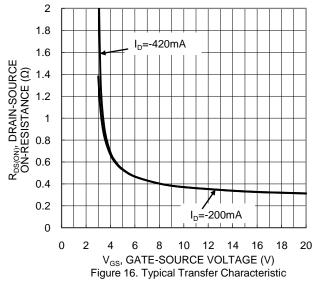
10 R<sub>DS(ON)</sub> Limited ID, DRAIN CURRENT (A) 1 0.1 T<sub>J(Max)</sub>=150℃ 0.01 T<sub>A</sub>=25°C V<sub>GS</sub>=10V Single Pulse DUT on 1\*MRP Board 0.001  $\begin{array}{ccc} & 1 & 10 \\ V_{\rm DS}, \, {\rm DRAIN\text{-}SOURCE} \,\, {\rm VOLTAGE} \,\, ({\rm V}) \\ {\rm Figure} \,\, 12. \,\, {\rm SOA}, \, {\rm Safe} \,\, {\rm Operation} \,\, {\rm Area} \end{array}$ 0.1 100

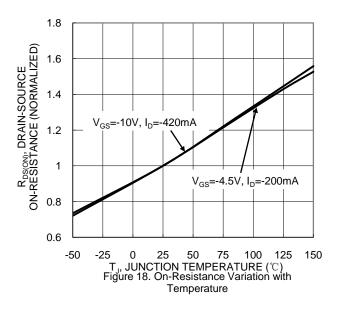


### **Typical Characteristics - P-CHANNEL**



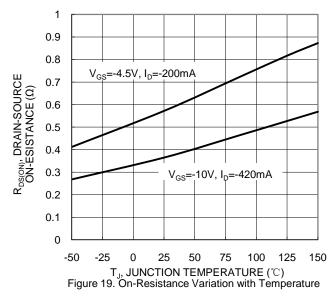


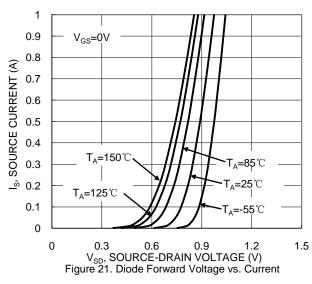


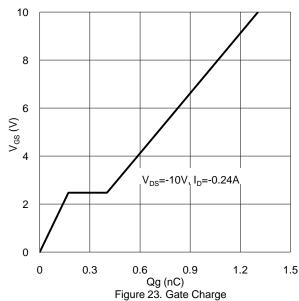


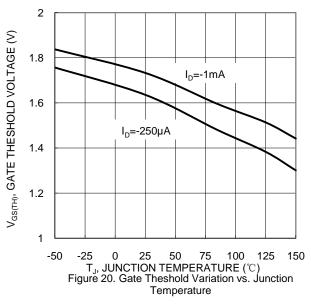
Current and Temperature

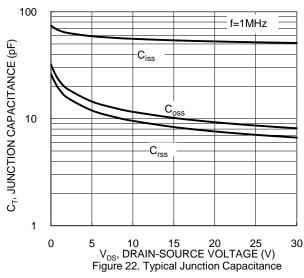


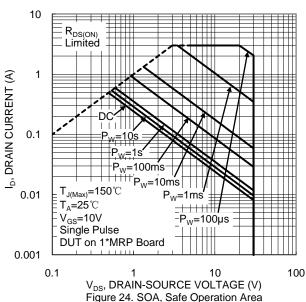




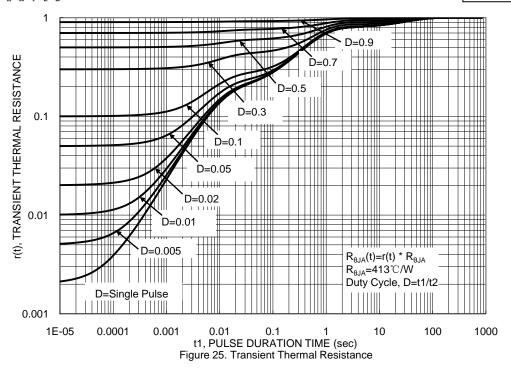






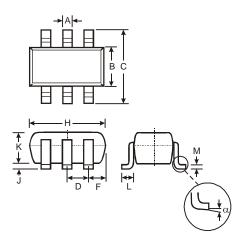






### **Package Outline Dimensions**

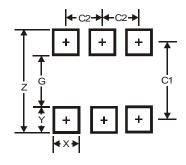
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf the for latest version.



|     | SOT363               |      |       |  |  |  |  |  |  |
|-----|----------------------|------|-------|--|--|--|--|--|--|
| Dim | Min                  | Max  | Тур   |  |  |  |  |  |  |
| Α   | 0.10                 | 0.30 | 0.25  |  |  |  |  |  |  |
| В   | 1.15                 | 1.35 | 1.30  |  |  |  |  |  |  |
| С   | 2.00                 | 2.20 | 2.10  |  |  |  |  |  |  |
| D   | 0.65 Typ             |      |       |  |  |  |  |  |  |
| F   | 0.40                 | 0.45 | 0.425 |  |  |  |  |  |  |
| Н   | 1.80                 | 2.20 | 2.15  |  |  |  |  |  |  |
| J   | 0                    | 0.10 | 0.05  |  |  |  |  |  |  |
| K   | 0.90                 | 1.00 | 1.00  |  |  |  |  |  |  |
| L   | 0.25                 | 0.40 | 0.30  |  |  |  |  |  |  |
| М   | 0.10                 | 0.22 | 0.11  |  |  |  |  |  |  |
| α   | 0°                   | 8°   | -     |  |  |  |  |  |  |
| All | All Dimensions in mm |      |       |  |  |  |  |  |  |

### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf the for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 2.5           |
| G          | 1.3           |
| Х          | 0.42          |
| Υ          | 0.6           |
| C1         | 1.9           |
| C2         | 0.65          |



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